WNSC2D201200BT2



Silicon Carbide Diode Rev.01 - 19 October 2022

**Product data sheet** 

## **1. General description**

Silicon Carbide Schottky diode in a TO263-2L (D2PAK) plastic package, designed for high frequency switched-mode power supplies.



# 2. Features and benefits

- · Highly stable switching performance
- High forward surge capability I<sub>FSM</sub>
- Extremely fast reverse recovery time
- Superior in efficiency to Silicon Diode alternatives
- Reduced losses in associated MOSFET
- Reduced EMI
- Reduced cooling requirements
- RoHS compliant
- High junction operating temperature capability (T<sub>j(max)</sub> = 175 °C)

## 3. Applications

- Power factor correction
- Telecom/Server SMPS
- UPS
- PV inverter
- PC Silverbox
- LED/OLED TV
- Motor Drives

## 4. Quick reference data

Table 1. Q	uick reference data						
Symbol	Parameter	Conditions	Notes	Values			Unit
Absolute maximum rating							
$V_{\text{RRM}}$	repetitive peak reverse voltage				1200		V
$\mathbf{I}_{F(AV)}$	average forward current	δ = 0.5 ; square-wave pulse; T <sub>mb</sub> ≤ 136 °C; Fig. 1; Fig. 2; Fig. 3		20		A	
Tj	junction temperature			-55 to 175		°C	
Symbol	Parameter	Conditions	Notes	Min Typ Max		Unit	
Static ch	aracteristics						
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 20 A; T <sub>j</sub> = 25 °C; <u>Fig. 5</u>		-	1.45	1.65	V
		I <sub>F</sub> = 20 A; T <sub>j</sub> = 150 °C; <u>Fig. 5</u>		-	1.95	2.30	V
		I <sub>F</sub> = 20 A; T <sub>j</sub> = 175 °C; <u>Fig. 5</u>		-	2.10	2.60	V
Dynamic	characteristics	·					
Q <sub>r</sub>	recovered charge	$I_F = 20 \text{ A}; \text{ d}I_F/\text{d}t = 500 \text{ A}/\mu\text{s}; \text{ V}_R = 400 \text{ V};$ $T_j = 25 \text{ °C}; \frac{\text{Fig. 7}}{2}$		-	45	-	nC

# **5. Pinning information**

Table 2. P	inning infor	mation		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	К	cathode	mb	
2	А	anode		K — A 001aaa020
mb	mb	mounting base; connected to cathode	ТО-263 (D2PAK)	

# 6. Ordering information

Table 3. Ordering information							
Type number	Package name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date	
WNSC2D201200BT2	TO263-2L	WNSC2D201200BT26J	Reel	800	TO263N-2L	14-Oct-2022	

## 7. Marking

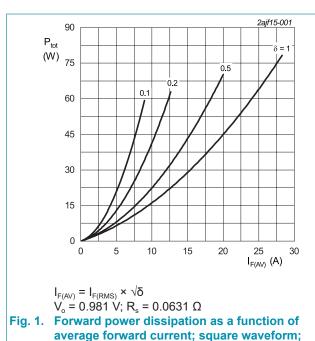
Table 4. Marking codes						
Type number	Marking codes					
WNSC2D201200BT2	WNSC2D 201200BT2					

# 8. Limiting values

### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Notes	Values	Unit
$V_{RRM}$	repetitive peak reverse voltage			1200	V
V <sub>RWM</sub>	crest working reverse voltage			1200	V
V <sub>R</sub>	reverse voltage	DC		1200	V
I <sub>F(AV)</sub>	average forward current	δ = 0.5; square-wave pulse; T <sub>mb</sub> ≤ 136 °C; Fig. 1; Fig. 2; Fig. 3		15	A
I <sub>FRM</sub>	repetitive peak forward current	$\delta$ = 0.5; t <sub>p</sub> = 25 µs; T <sub>mb</sub> ≤ 136 °C; square-wave pulse		30	A
I <sub>FSM</sub>	non-repetitive peak	$t_p$ = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse		160	А
	forward current	$t_p$ = 10 µs; $T_{j(init)}$ = 25 °C; square-wave pulse		1000	А
l <sup>2</sup> t	l <sup>2</sup> t for fusing	sine-wave pulse; $T_{j(init)}$ = 25 °C; $t_p$ = 10 ms		128	A <sup>2</sup> s
T <sub>stg</sub>	storage temperature			-55 to 175	°C
T <sub>j</sub>	junction temperature			-55 to 175	°C



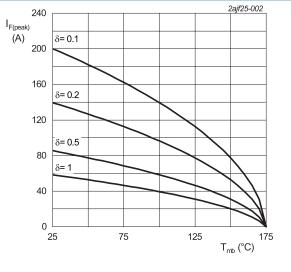
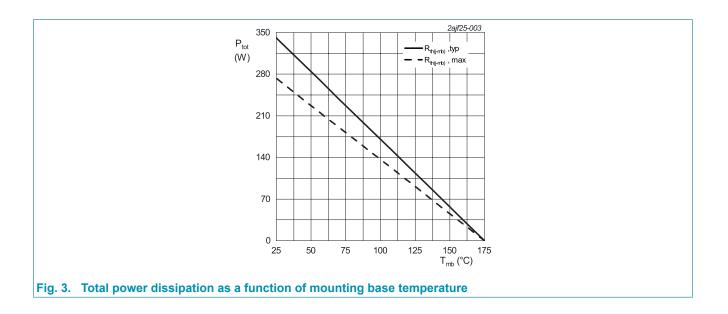


Fig. 2. Current derating as a function of mounting base temperature

maximum values

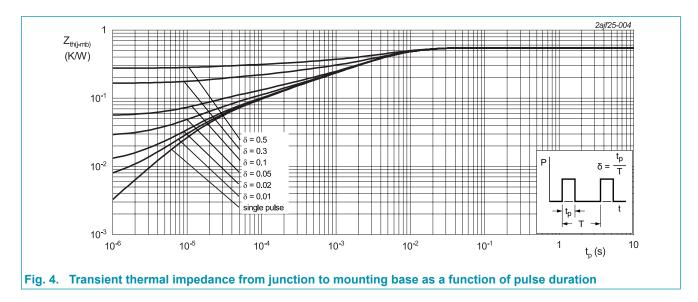
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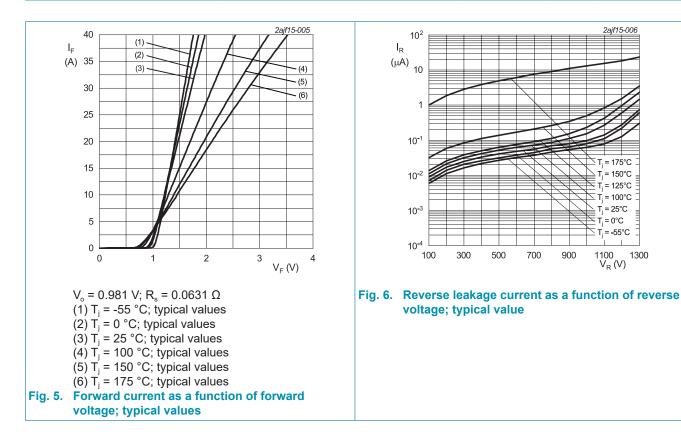
# 9. Thermal characteristics

Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
$R_{\text{th}(j\text{-}mb)}$	thermal resistance from junction to mounting base	<u>Fig. 4</u>		-	0.44	0.55	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	in free air		-	40	-	K/W



## **10. Characteristics**

Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static cha	racteristics						
V <sub>F</sub>	forward current	I <sub>F</sub> = 20 A; T <sub>j</sub> = 25 °C; <u>Fig. 5</u>		-	1.45	1.65	V
		I <sub>F</sub> = 20 A; T <sub>j</sub> = 150 °C; <u>Fig. 5</u>		-	1.95	2.30	V
		I <sub>F</sub> = 20 A; T <sub>j</sub> = 175 °C; <u>Fig. 5</u>		-	2.10	2.60	V
I <sub>R</sub>	reverse current	V <sub>R</sub> = 1200 V; T <sub>j</sub> = 25 °C; <u>Fig. 6</u>		-	1	100	μA
		V <sub>R</sub> = 1200 V; T <sub>j</sub> = 175 °C; <u>Fig. 6</u>		-	25	-	μA
Dynamic	characteristics						
Qr	recovered charge	$I_F = 20 \text{ A}; V_R = 400 \text{ V}; \text{ d}I_F/\text{d}t = 500 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 7$		-	45	-	nC
C <sub>d</sub>	diode capacitance	f = 1 MHz; V <sub>R</sub> = 1 V; T <sub>j</sub> = 25 °C		-	950	-	pF
		f = 1 MHz; V <sub>R</sub> = 400 V; T <sub>j</sub> = 25 °C		-	86	-	pF
		f = 1 MHz; V <sub>R</sub> = 800 V; T <sub>j</sub> = 25 °C		-	64	-	pF
E <sub>as</sub>	non-repetitive avalanche energy	I <sub>R</sub> = 5.3 A; L = 10 mH; T <sub>j(init)</sub> = 25 °C		140	-	-	mJ



2ajf15-006

∑ T<sub>j</sub> = 175°C

∑ T<sub>j</sub> = 100°C Ξ T<sub>j</sub> = 25°C

∑ T<sub>j</sub> = -55°C

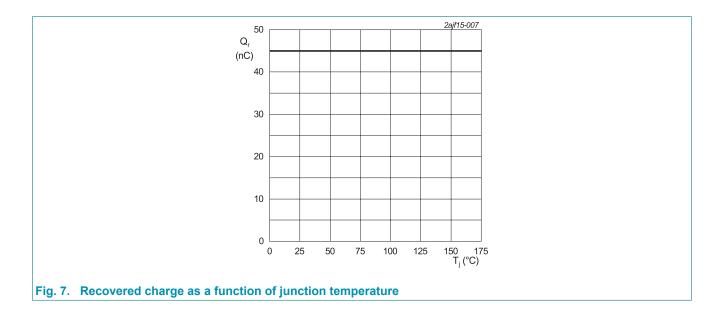
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1100 1300 V<sub>R</sub>(V)

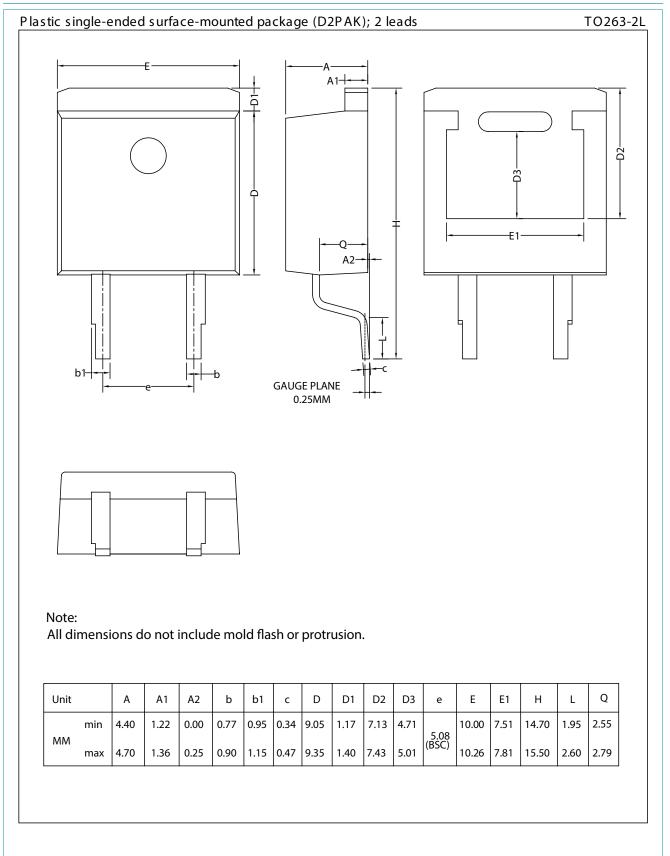
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## **11. Package outline**



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Product data sheet

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### Silicon Carbide Diode

# 12. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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